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BASiC Semiconductor Co., Ltd.
深圳基本半導體股份有限公司

(A joint stock company incorporated in the People's Republic of China with limited liability)
(Stock Code: 9971)

VOLUNTARY ANNOUNCEMENT

STRATEGIC COOPERATION AGREEMENT REACHED BETWEEN BASIC SEMICONDUCTOR AND EPISIL TECHNOLOGIES

This announcement is made by BASiC Semiconductor Co., Ltd. (the “**Company**” or “**BASiC Semiconductor**”) on a voluntary basis for the purpose of keeping the shareholders of the Company and potential investors abreast of the latest business development of the Company.

On August 4, 2026, the Company has reached a strategic cooperation agreement with Episil Technologies Inc. (“**Episil Technologies**”), a joint stock company with limited liability established in Taiwan, China, whose shares are listed on Taiwan Stock Exchange, China (stock code: 3707. TW).

Under this strategic cooperation, the parties will build upon their long-standing collaboration to accelerate the development and mass production of 8-inch silicon carbide (SiC) wafers. Leveraging BASiC Semiconductor’s advanced product technologies and market advantages, together with Episil Technologies’ high-quality, high-volume wafer manufacturing capabilities, they will jointly advance the development and volume production ramp-up of new process platforms, thereby expanding the market share of SiC products in key sectors such as new energy vehicles and AI data centres. In addition, the parties will conduct research on core process and application technologies for novel compound semiconductors in frontier application areas.

The Board of the Company believes that this strategic cooperation is expected to provide the Company with advanced and sufficient 8-inch SiC wafer fabrication capacity in the coming years, enabling the parties to achieve significant breakthroughs in market expansion and technology iteration.

Shareholders and potential investors are advised to exercise caution when dealing in the securities of the Company.

By order of the Board
BASiC Semiconductor Co., Ltd.
Dr. Wang Zhihan
Chairman

Shenzhen, August 4, 2026

As at the date of this announcement, the Board of the Company comprises: (i) Dr. Wang Zhihan, Dr. He Weiwei, Mr. Fu Junyin and Ms. Yan Rui as executive Directors; and (ii) Mr. Li Juping, Mr. Ye Xiang and Mr. Wang Susheng as independent non-executive Directors.